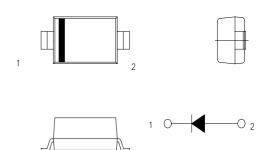
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$\begin{array}{ll} \textbf{DIODE} & \mathrm{Type} : EP05DA40 \end{array}$

Electrostatic Discharge Reinforcement Type

FEATURES

- * JEDEC SOD-123 Package
- * Very Low profile 1.1mm Max
- * High Surge Capability
- * Low Forward Voltage Drop
- * Low Reverse Leakage Current
- * Packaged in 8mm Tape and Reel



OUTLINE DRAWING

Maximum Ratings

Approx Net Weight:0.011g

Rating	Symbol	EC10DA40		
Repetitive Peak Reverse Voltage	V _{RRM}	400		
Non-repetitive Peak Reverse Voltage	V _{RSM}	450		
Average Rectified Output Current	Io	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	A	
RMS Forward Current	I _{F(RMS)}	1.57		
Surge Forward Current	I _{FSM}	25 SoHz Half Sine Wave,1cycle Non-repetitive		
Operating JunctionTemperature Range	Tjw	-40 to +150		
Storage Temperature Range	T _{stg}	-40 to +150		

Electrical • Thermal Characteristics

Characteristics	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Peak Reverse Current	I_{RM}	Tj= 25°C, V _{RM} = V _{RRM}	-	-	10	μΑ	
Peak Forward Voltage	V_{FM}	Tj= 25°C, I _{FM} = 0.5A	-	-	1.05	V	
Electrostatic Discharge	-	Tj= 25°C, C = 150 pF, R = 150 ohm *2	ı	25	-	kV	
Thermal Resistance	Rth _(j-a)	Junction to Ambient *1	-	-	300	°C/W	
	Rth _(i-l)	Junction to Lead	-	-	70		

^{*1} Glass Epoxy Substrate Mounted (Soldering Lands=2x2mm,Both Sides)

^{*2} Mesured by ESS-630S of NOISE LABORATORY

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EP05DA40 OUTLINE DRAWING (Dimensions in mm)

